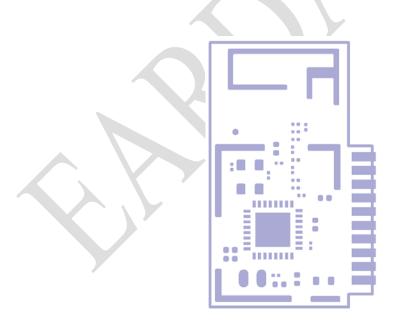


EWN-8250FGT1AA EWN-8258FAT1BA

Datasheet V1.3

BT Mesh Soc Module



E-mail: sales@eardatek.com



E-mail: sales@eardatek.com

EWN-8258FAT1BA

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E-mail: sales@eardatek.com

EWN-8258FAT1BA

1 General Specifications

EWN-8250FGT1AA/EWN-8258FAT1BA is Bluetooth LE Soc solution with internal flash. It combines the radio frequency, digital processing, protocols stack software ,profiles for Bluetooth Low Energy(up to Bluetooth 5) and Tmall Genie Mesh into a single Soc.

2 Features

- Bluetooth 5 Compliant
- 2Mbps LE
- Long Range 125Kbps and 500Kbps support Tmall Genie Mesh
- Support BLE and Tmall Genie Mesh into a single SoC without the requirement for an external DSP
- BLE transceiver embedded
- Embedded hardware acceleration for Elliptical curve cryptography (ECC) used in BLE 4.2 and above
- Program memory: internal 512kB Flash(EWN-8250FGT1AA)/

1MB Flash (EWN-8258FAT1BA)

- Data memory: 48kB on-chip SRAM (EWN-8250FGT1AA)/ 64kB on-chip SRAM (EWN-8258FAT1BA).
- Write protect all or portions of memory
- Multi firmware encryption methods for anti-cloning protection
- Embedded hardware AES and AES-CCM
- Multiple stage power management to minimize power consumption
- SWS independent Download and Debug interface
- 14bit 10-channel SAR ADC
- I/O: UART, PWM



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3 System Block Diagram

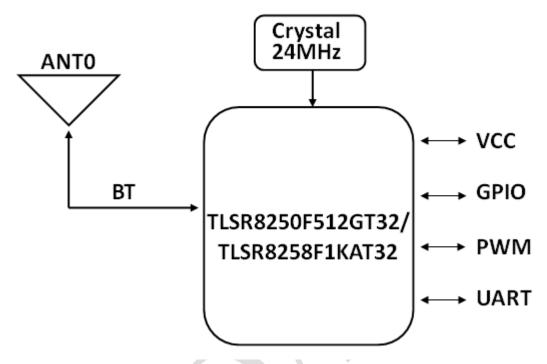


Fig 1 System Block Diagram

4 PHY Specification

Table 1 Bluetooth RF Parameters

Protocol	BT5.0
Interface	UART
Frequency	2380 MHz ~ 2500MHz (Programmable in 1MHz step)
Data rate	BLE 1Mbps,±250KHz deviation



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Table 2 RX Performance

Item	Sym.	Min.	Тур.	Max.	Unit	Condition
BLE 1Mbps RF_Rx performance (±250KHz deviation)						
Sensitivity	1Mbps		-95		dBm	
Frequency Offset Tolerance		-250		+300	KHz	
Co-channel rejection			-11		dB	Wanted signal at -67dBm
Image rejection			37		dB	Wanted signal at -67dBm
In-band blocking	+1/-1 MHz offset		1/3		dB	
rejection (Equal Modulation	+2/-2 MHz offset		37/39		dB	Wanted signal at -67dBm
Interference)	>=3 MHz offset		42		dB	

Table 3 TX Performance

Item	Sym.	Min.	Тур.	Max.	Unit	Condition
		BLE 1Mb	ps RF_TX p	erformance		
Output power, maximum setting			10		dBm	
Output power, minimum setting			-45		dBm	
Programmable output power range			55		dB	
Modulation 20dB bandwidth			2.5		MHz	



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5 Other Specifications

Table 4 other Specifications

Operating Temperature	-40°C~+105°C
Store Town Control	Module: -40°C~+105°C
Storage Temperature	Package: -20°C~+70°C
Operating Humidity	RH 95%(Non-Condensing)
Storage Humidity	RH 95%(Non-Condensing)
Humidity level	Level 3

6 DC Specifications

Table 5 DC Specifications

lable 3 DC specifications						
Item	Sym.	Min.	Тур.	Max.	Unit	Condition
VDD_3.3V	V_{BAT}	1.8	3.3	3.6	V	3.3V Supply Voltage
RX current	I_{RX}	-	5.3	-	mA	whole chip
TX current	I_{TX}	-	4.8	-	mA	whole chip @0dBm with DCDC
TX current	I_{TX}		20	-	mA	whole chip @10dBm with DCDC
Deep sleep with 8kB SRAM retention			1		uA	uA
Deep sleep with 16kB SRAM retention	I _{deep1}		1.2		uA	uA
Deep sleep with 32kB SRAM retention		,	1.4		uA	uA
Deep sleep without SRAM retention	I _{deep2}		0.4		uA	uA



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7 Module configurations

Module Size (Unit: mm): 24.5(±0.3) *15.0(±0.25)*2.4(±0.2)

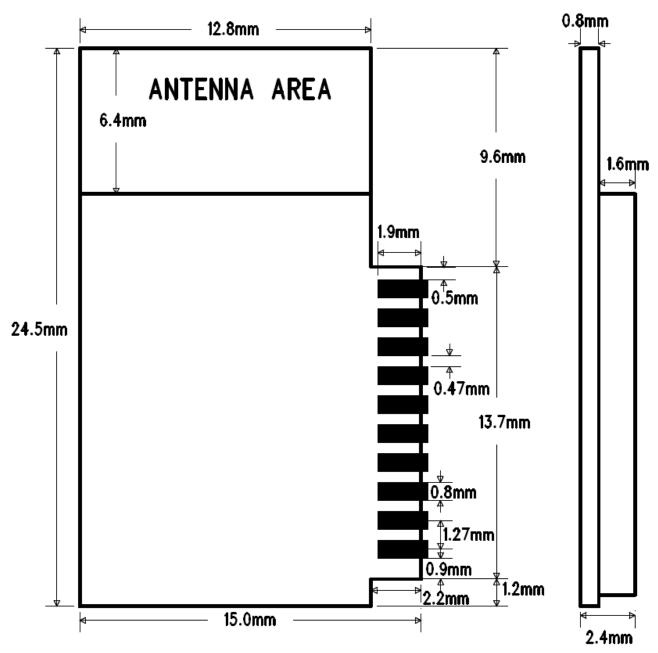


Fig 2 Module Size (Top view)



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8 Pin Definition



Fig 3 Top view

Table 6 the hardware Pin definition of the module

Table 6 Pin definition

PIN	Definition	IC Pin	Description
1	VBAT	/	Supply power 1.8V-3.3V ;
2	GND	/	Module power reference
3	PWM0	PC1	PWM output for LED drive (Default control cold white light) ;



Module: EWN-8250FGT1AA EWN-8258FAT1BA

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			EWIN-02JOFATIDA
PIN	Definition	IC Pin	Description
			General I/O port ;
			PWM output for LED drive (Default control
4	PWM1	PC3	warm white light) ;
4	L ANIAIT	PCS	SAR ADC Input ;
			General I/O port ;
			PWM output for LED drive (Default control
5	PWM4	PB4	Red light) ;
)	P VV IVI4	PD4	SAR ADC Input ;
			General I/O port ;
			PWM output for LED drive (Default control
6	PWM5	PB5	Green light) ;
			General I/O port ;
			PWM output for LED drive (Default control
7	PWM2	PC4	Blue light) ;
			General I/O port ;
8	ADC	PB6	SAR ADC Input ;
O	ADC	PB0	General I/O port ;
	LIADT TV	DD1	Serial port sending data ;
9	UART_TX	PB1	General I/O port ;
10	LIADT DV	DD7	Serial port receiving data ;
10	UART_RX	PB7	General I/O port ;

Notes:

- 1. Download Interface use SWS test point.
- 2. Only SWS interface can be used for debugging firmware.



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9 Module Photos



FIG 4 Top View



FIG 5 Bottom View

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10 Key material list

Table 7 Key material list

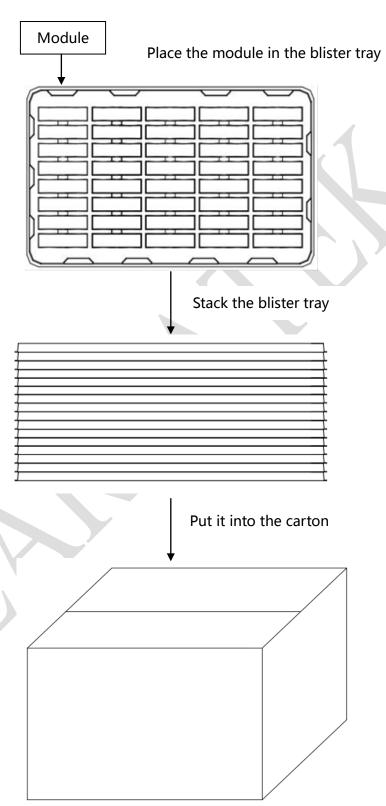
Туре	Model	Footprint	QTY.
Crystal	24MHz 12pF 20ppm	3225	1PCS
Inductance	10uH	0805	1PCS
IC	TLSR8250F512GT32 (only for EWN-8250FGT1AA)	QFN32	1PCS
IC	TLSR8258F1KAT32 (only for EWN-8258FAT1BA)	QFN32	1PCS



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11Package Information





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12 Reference design

12.1 RF

a) Under the antenna and in the two directions indicated by the arrow, avoid covering the ground, routing and placing metal components. It is better to directly hollow out the PCB in this area.

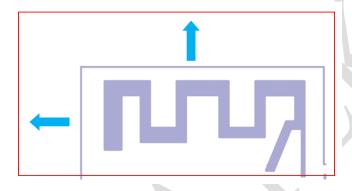


Fig 6 Antenna

- b) It is recommended not to use any components within 30mm of the module antenna area, and the module baseboard should also avoid wiring and covering the ground as much as possible.
- c) It is strongly recommended that the user place the antenna of the Bluetooth module close to the edge of the backplane as far as possible when laying out the PCB, as shown in the figure below, so as to ensure the good performance of the antenna.



Fig 7 Recommended PCB layout

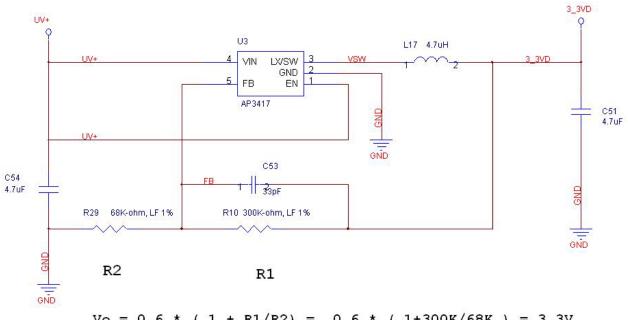


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12.2 Power supply requirement

The module power supply voltage is DC+3.3V. The power supply design needs to consider the output current and power interference. The power supply current design needs to reserve 50mA. To avoid the +3.3V power supply from interfering with other circuits on the motherboard, it is recommended to supply to the module using the regulator circuit alone, the recommended DC-DC circuit structure shown in the figure below. A 4.7uF~10uF capacitor is connected in parallel at 3_3VD output to filter out the interference. A bead is connected in series at 3_3VD output. The bead and capacitor must be placed as close to the module as possible. If you need to share +3.3V with other circuits, consider whether the current of the shared power supply is sufficient.



Vo = 0.6 * (1 + R1/R2) = 0.6 * (1+300K/68K) = 3.3V Step-Down Regulator, Vfb=0.6V, 1A, 1.8MHz, ADJ, LF Fig 8 Power supply Circuit schematic



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12.3 Motherboard interference avoidance

Motherboard interference comes from: high-speed data interface (HDMI), the Operating frequency of main chip, DDR, DC-DC power supply. The method of avoiding interference according to the characteristics of various signals is also different. The main methods of interference avoidance include:

- 1. keeping away from the source of interference;
- 2. Adding shields to avoid interference leakage;
- 3. Reasonable layout to eliminate interference.

12.3.1 Interface interference

When HDMI uses the 74.2MHz frequency, its 33x frequency is in the 2.4G band of BT, which will seriously interfere with the BT signal. If the HDMI frequency is 148.5MHz, although the 16x frequency is not in the BT band, the isolation of the frequency is not good, and the BT signal will be interfered to some extent. If the distance between the HDMI interface and the BT module on the PCB is less than 5cm, the HDMI output display will interfere with the BT signal, resulting in problems such as BT connection failure and throughput drop. Therefore, keep the location of the BT module away from the HDMI port on the hardware layout to avoid interference.

At the same time, if the BT antenna is built-in the motherboard, its placement must also be carefully considered to be far from the interface interference. If the antenna is placed in an incorrect position, even if the module is shielded, the interference signal is coupled through the antenna, which will eventually result in a lower BT throughput. (Note: In addition to interference, the placement of the internal antenna should also evaluate the effect of the metal interface, motherboard, and housing material on the antenna impedance.)



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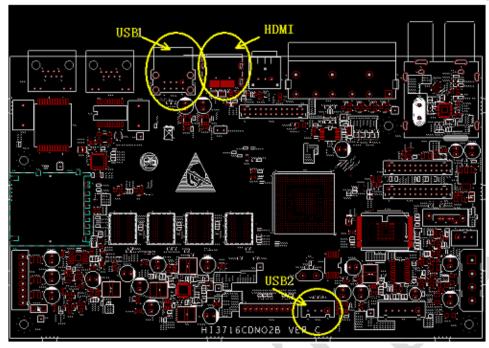


Fig 9 HDIM and USB interference

12.3.2 The main chip interferes with DDR

Because the main chips operate at about 800MHz or DDR2 operate at 667MHz, 3x frequency of 800MHz and 4x frequency of 667MHz are near 2.4GHz band. It must to place BT modules and antennas far away from the main chip and DDR. It is strongly recommended that the main chip be isolated from the DDR by a shield. As shown in the figure below.

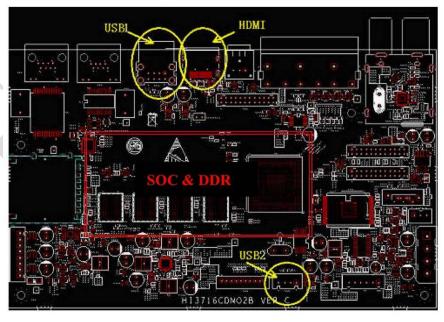


Fig 10 Main chip and DDR interference



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12.4 Recommended secondary reflux temperature curve

The number of reflux shall not exceed 2 times, and the tin feeding height of the half hole of the module shall be no less than 1/4.

The lead-free reflux curve requirements of BT module products are shown in figure 11:

Stage	Note	Pb-free assembly
Average ramp-up rate	T _L to Tp	3 °C/ second max.
Preheat	Temperature min (T _{smin})	150℃
	Temperature max (Tsmax)	200℃
	Time (t _{smin} to t _{smax})	60 - 120 seconds
Time maintained	Temperature(T _L)	217℃
above	Time (t _L)	60 - 150 seconds
Peak package body	temperature (Tp)	Tp must not exceed the specified classification temp(Tc=245 ℃).
Time(tp) within 5°C	of the specified	30 seconds
classification temper	ature (Tc)	
Ramp-down rate (Tp	to T _L)	6 ℃ / seconds max.
Time 25°C to peak to	emperature	8 minutes max.

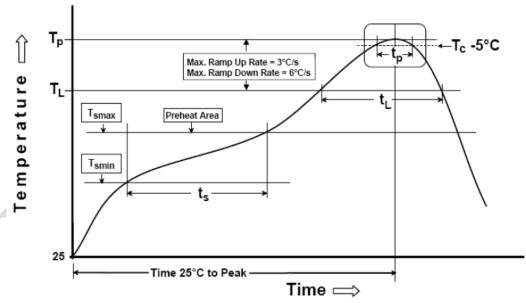


Fig 11 Furnace temperature curve

Note:

- 1. The maximum furnace temperature of the module is 260°C, don't exceed this temperature.
 - 2. The gold plating thickness of the module pad is 2u".



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13WARNING

13.1 FCC WARNING

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference, and
- (2) This device must accept any interference received, including interference that may cause undesired operation.

Warning: Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

Reorient or relocate the receiving antenna.

Increase the separation between the equipment and receiver.

Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.

Consult the dealer or an experienced radio/TV technician for help.

FCC Radiation Exposure Statement:

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator & your body.



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13.2 IC Caution

Radio Standards Specification RSS-Gen, issue 5

- English:

This device contains licence-exempt transmitter(s)/receiver(s) that comply with Innovation, Science and Economic Development Canada's licence-exempt RSS(s). Operation is subject to the following two conditions:

This device may not cause interference.

This device must accept any interference, including interference that may cause undesired operation of the device.

RF exposure statement:

The equipment complies with IC Radiation exposure limit set forth for uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator and your body.

- French:

Cet appareil contient des émetteurs / récepteurs exemptés de licence conformes aux RSS (RSS) d'Innovation, Sciences et Développement économique Canada. Le fonctionnement est soumis aux deux conditions suivantes:

Cet appareil ne doit pas causer d'interférences.

Cet appareil doit accepter toutes les interférences, y compris celles susceptibles de provoquer un fonctionnement indésirable de l'appareil.

Déclaration d'exposition RF:

L'équipement est conforme à la limite d'exposition aux radiations de la IC établie pour un environnement non contrôlé. Cet équipement doit être installé et utilisé avec une distance minimale de 20 cm entre le radiateur et votre corps.



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14Revision History

Revision	Release Date	Summary	Revised By
V1.0	2019-11-19	First release	Guo.QL
V1.1	2020-07-22	Modify the picture, change the module pin size, modify the specification	Guo.QL
V1.2	2020-08-05	Increase current requirement; Modify dimension drawing; Add packing method	Guo.QL
V1.3	2020-8-12	Added EWN-8258FAT1BA	Guo.QL

Integration instructions for host product manufacturers according to KDB 996369 D03 OEM Manual v01

2.2 List of applicable FCC rules

FCC Part 15 Subpart C 15.247 & 15.207 & 15.209

2.3 Specific operational use conditions

The module is a Bluetooth module with BLE function.

Operation Frequency: 2402-2480MHz

Number of Channel: 40 Modulation: GFSK Type: PCB Antenna Gain: 0.5dBi Max.

The module can be used for mobile or portable applications with a maximum 0.5dBi antenna. The host manufacturer installing this module into their product must ensure that the final composit product complies with the FCC requirements by a technical assessment or evaluation to the FCC rules, including the transmitter operaition. The host manufacturer has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module. The end user manual shall include all required regulatory information/warning as show in this manual.

2.4 Limited module procedures

Not applicable. The module is a Single module and complies with the requirement of FCC Part 15.212.

2.5 Trace antenna designs

Not applicable. The module has its own antenna, and doesn't need a host's printed board microstrip trace antenna etc.

2.6 RF exposure considerations

The module must be installed in the host equipment such that at least 5mm is maintained between the antenna and users' body; and if RF exposure statement or module layout is changed, then the host product manufacturer required to take responsibility of the module through a change in FCC ID or new application. The FCC ID of the module cannot be used on the final product. In these circumstances, the host manufacturer will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization.

2.7 Antennas

Antenna Specification are as follows:

Type: PCB Antenna

Gain: 0.5dBi

This device is intended only for host manufacturers under the following conditions:

The transmitter module may not be co-located with any other transmitter or antenna;

The module shall be only used with the internal antenna(s) that has been originally tested and certified with this module. The antenna must be either permanently attached or employa 'unique' antenna coupler.

As long as the conditions above are met, further transmitter test will not be required. However, the host manufacturer is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc.).

2.8 Label and compliance information

Host product manufacturers need to provide a physical or e-label stating "Contains FCC ID: **2AMM6-825X1BA**" with their finished product.

2.9 Information on test modes and additional testing requirements

Operation Frequency: 2402-2480MHz

Number of Channel: 40 Modulation: GFSK

Host manufacturer must perfor test of radiated & conducted emission and spurious emission, etc according to the actual test modes for a stand-alone modular transmitter in a host, as well as for multiple simultaneously transmitting modules or other transmitters in a host product.

Only when all the test results of test modes comply with FCC requirements, then the end product can be sold legally.

2.10 Additional testing, Part 15 Subpart B disclaimer

The modular transmitter is **only** FCC authorized for FCC Part 15 Subpart C 15.247 & 15.207 & 15.209 and that the host product manufacturer is responsible for compliance to any other FCC rules that apply to the host not covered by the modular transmitter grant of certification. If the grantee markets their product as being Part 15 Subpart B compliant (when it also contains unintentional-radiator digital circuity), then the grantee shall provide a notice stating that the final host product still requires Part 15 Subpart B compliance testing with the modular transmitter installed.

Federal Communication Commission Statement (FCC, U.S.)

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

FCC Caution:

Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate this equipment.

IMPORTANT NOTES

Co-location warning:

This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter.

OEM integration instructions:

This device is intended only for OEM integrators under the following conditions:

The transmitter module may not be co-located with any other transmitter or antenna. The module shall be only used with the external antenna(s) that has been originally tested and certified with this module.

As long as the conditions above are met, further transmitter test will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc.).

Validity of using the module certification:

In the event that these conditions cannot be met (for example certain laptop configurations or co-location with another transmitter), then the FCC authorization for this module in combination with the host equipment is no longer considered valid and the FCC ID of the module cannot be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization.

End product labeling:

The final end product must be labeled in a visible area with the following: "Contains Transmitter Module FCC ID: 2AMM6-825X1BA.

Information that must be placed in the end user manual:
The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module. The end user manual shall include all required regulatory information/warning as show in this manual.